

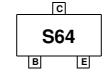


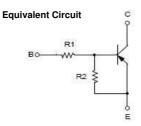
# FJY4014R PNP Epitaxial Silicon Transistor

## **Features**

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R<sub>1</sub>=4.7K $\Omega$ , R<sub>2</sub>=47K $\Omega$ )
- · Complement to FJY3014R







# Absolute Maximum Ratings \* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	-50	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-50	V
V <sub>EBO</sub>	Emitter-Base Voltage	-10	V
I <sub>C</sub>	Collector Current	-100	mA
T <sub>STG</sub>	Storage Temperature Range	-55~150	°C
T <sub>J</sub>	Junction Temperature	150	°C
P <sub>C</sub>	Collector Power Dissipation, by R <sub>0JA</sub>	200	mW

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

# Thermal Characteristics\* Ta=25°C unless otherwise noted

R <sub>0.10</sub> Thermal Resistance, Junction to Ambient		Units	
Π <sub>θ</sub> JA Thermal Resistance, Junction to Ambient	°C/W	°C/W	

# Electrical Characteristics\* T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	MIN	Тур	MAX	Units
V <sub>(BR)</sub> CBO	Collector-Emitter Breakdown Voltage	Ic = -10 uA, IE = 0	-50			V
V <sub>(BR)CEO</sub>	Collector-Base Breakdown Voltage	Ic = -100 uA, IB = 0	-50			V
Ісво	Collector-Cutoff Current	Vcb = -40 V, IE = 0			-0.1	uA
hfE	DC Current Gain	Vce = -5 V, Ic = -5mA	68			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	Ic = -10 mA, I <sub>B</sub> = -0.5 mA			-0.3	V
f⊤	Current Gain - Bandwidth Product	VcE = -10V, Ic = -5 mA		200		MHz
Ccb	Output Capacitance	Vcb = -10 V, IE = 0, f = 1.0 MHz		5.5		pF
V <sub>I</sub> (off)	Input Off Voltage	Vce = -5 V, Ic = -100uA	-0.5			V
V <sub>I</sub> (on)	Input On Voltage	VcE = -0.2V, Ic = -5mA			-1.3	V
R <sub>1</sub>	Input Resistor		3.2	4.7	6.2	ΚΩ
R <sub>1</sub> /R <sub>2</sub>	Resistor Ratio		0.09	0.1	0.11	

<sup>\*</sup> Pulse Test: PW≤300μs, Duty Cycle≤2%

# **Typical Performance Characteristics**

Figure 1. DC current Gain

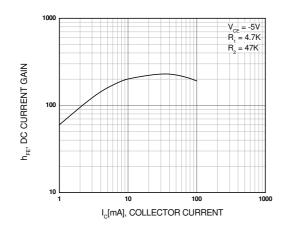


Figure 2. Input On Voltage

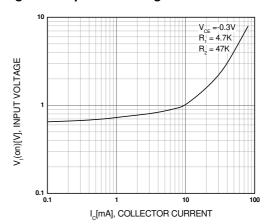


Figure 3. Collector-Emitter Saturation Voltage

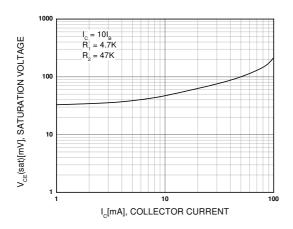
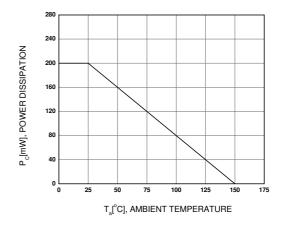


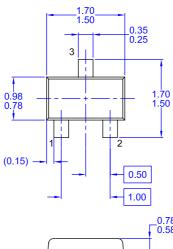
Figure 4. Power Derating

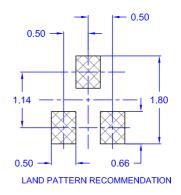


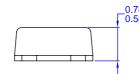
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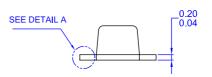
# **Package Dimensions**

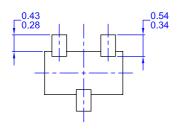
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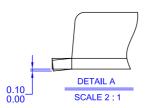












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Dimensions in Millimeters





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